



# Product Change Notification

## 108991 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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# Product Change Notification

**Change Notification #:** 108991 - 00  
**Change Title:** uSata Connector Gold plating thickness increase, PCN 108991-00, Product Design, in 1.8in Solid-State Drive  
**Date of Publication:** December 10, 2008

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	Mar 01, 2009
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## Description of Change to the Customer:

uSATA mating gold plating interface contact area increased from 15ui to 30ui.

The following Label changes apply:

Product Label changes:

"SA" field from E40119-301 to E40119-302

"PBA" field from E31571-301 to E56137-301

CT Number Change:

UAGNA01G6LLMMM to UAGNA02G6LLMMM

Cartoon Label changes:

"Version" Field for MM# 898917 from E41859-301 to E41859-302

"Version" Field for MM# 900227 from E51511-301 to E51511-302

## Customer Impact of Change and Recommended Action:

Intel anticipates no form, fit or function impact to customer

## Products Affected / Intel Ordering Codes:

Pre Change Product Code	Pre Change MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
SSDSA1MH080G1HPS LG9B	898917	E41859-301	E31571-301	E41859-302	E56137-301
SSDSA1MH080G1H1900227	900227	E51511-301	E31571-301	E51511-302	E56137-301

## PCN Revision History:

<b>Date of Revision:</b>	<b>Revision Number:</b>	<b>Reason:</b>
December 10, 2008	00	Originally Published PCN